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FDS2672-F085 N-Channel UltraFET Trench[®] MOSFET

200V, 3.9A, 70mΩ

Features

- Max r_{DS(on)} = 70mΩ at V_{GS} = 10V, I_D = 3.9A
- Max $r_{DS(on)}$ = 80m Ω at V_{GS} = 6V, I_D = 3.5A
- Fast switching speed
- High performance trench technology for extremely low r_{DS(on)}
- Qualified to AEC Q101
- RoHS compliant

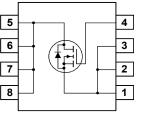
General Description

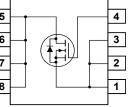
This single N-Channel MOSFET is produced using Trench® ON Semiconductor's advanced UltraFET Trench® process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC-DC conversion

D D D D SO-8 Pin





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage		200	V	
V _{GS}	Gate to Source Voltage		±20	V	
I _D	Drain Current -Continuous	(Note 1a)	3.9	— A	
	-Pulsed		50		
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	37.5	mJ	
P _D	Power Dissipation	(Note 1a)	2.5		
	Power Dissipation	(Note 1b)	1.0		
T _J , T _{STG}	Operating and Storage Temperature		-55 to 150	°C	
Therma	I Characteristics				
$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	25	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50		
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	125		

Device Marking	Device	Reel Size	Tape Width	Quantity
FDS2672	FDS2672-F085	13"	12mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Char	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250μA, V _{GS} = 0V	200			V	
ΔΒV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		206		mV/°C	
1	Zero Gate Voltage Drain Current	V _{DS} = 160V, V _{GS} =0V			1	μA	
I _{DSS}		V _{DS} = 160V, V _{GS} =0V T _J = 55°C			10	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V$			±100	nA	
On Char	acteristics (Note 2)						
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250μA 2		2.9	4	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$, referenced to 25°C		-11		mV/°C	
	Drain to Source On Resistance	V _{GS} = 10V, I _D = 3.9A		59	70		
r _{DS(on)}		V _{GS} = 6V, I _D = 3.5A		63	80	mΩ	
. ,		V_{GS} = 10V, I _D = 3.9A, T _J = 125°C		124	148		
9 _{FS}	Forward Transcondductance	V _{DS} = 10V,I _D = 3.9A		15		S	
	Characteristics						
C _{iss}	Input Capacitance	V _{DS} = 100V, V _{GS} = 0V,		1905	2535	pF	
C _{oss}	Output Capacitance	$v_{DS} = 100v, v_{GS} = 0v,$ = f = 1MHz		100	135	pF	
C _{rss}	Reverse Transfer Capacitance			30	45	pF	
Rg	Gate Resistance	f = 1MHz		0.7		Ω	
	g Characteristics						
Switchin	genalaetenetiee						
	Turn-On Delay Time			22	35	ns	
t _{d(on)}	-	$V_{DD} = 100V, I_D = 3.9A$		22 10	35 20	ns ns	
t _{d(on)} t _r	Turn-On Delay Time	V _{DD} = 100V, I _D = 3.9A V _{GS} = 10V, R _{GEN} = 6Ω					
t _{d(on)} t _r t _{d(off)}	Turn-On Delay Time Rise Time	55 5		10	20	ns	
t _{d(on)} t _r t _{d(off)} t _f	Turn-On Delay Time Rise Time Turn-Off Delay Time	55 5		10 35	20 56	ns ns	
t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time	55 5		10 35 10	20 56 20	ns ns ns	
$\begin{array}{c} t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_{g(TOT)} \\ Q_{gs} \end{array}$	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V	V_{GS} = 10V, R_{GEN} = 6 Ω		10 35 10 33	20 56 20	ns ns ns nC	
t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs} Q _{gd}	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Gate to Source Gate Charge	V_{GS} = 10V, R_{GEN} = 6 Ω		10 35 10 33 11	20 56 20	ns ns nC nC	
t _{d(on)} t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs} Q _{gd} Drain-So	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller"Charge	V_{GS}^{o} = 10V, R_{GEN}^{o} = 6 Ω V _{DD} =100V I _D = 3.9A		10 35 10 33 11	20 56 20	ns ns nC nC	
$\begin{array}{c} t_{d(on)} \\ t_r \\ t_{d(off)} \\ t_f \\ Q_{g(TOT)} \\ Q_{gs} \\ Q_{gd} \end{array}$	Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge at 10V Gate to Source Gate Charge Gate to Drain "Miller"Charge	V_{GS} = 10V, R_{GEN} = 6 Ω		10 35 10 33 11 7	20 56 20 46	ns ns nC nC nC	

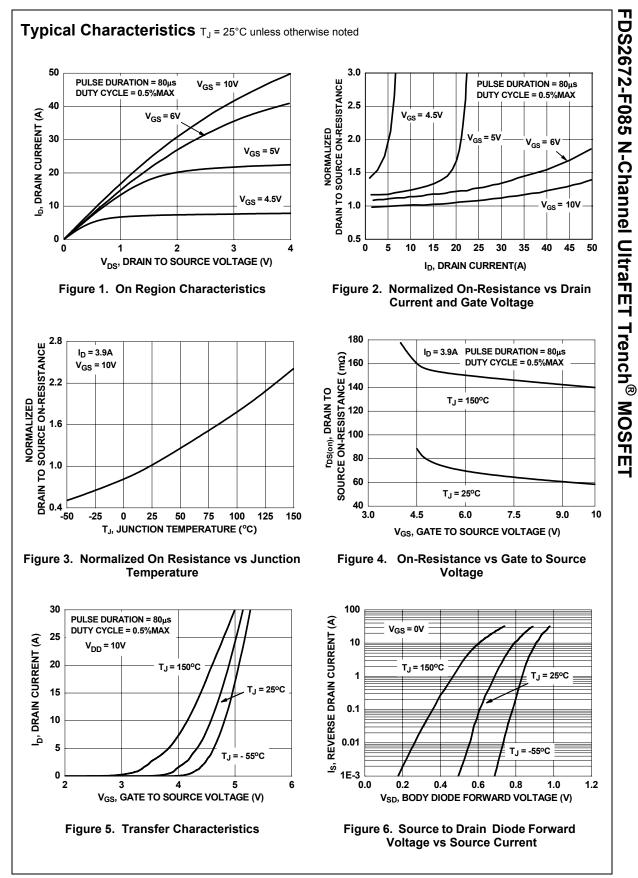
Notes:
1: R_{0JA} is the sum of the junction-to-case and case-to- ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



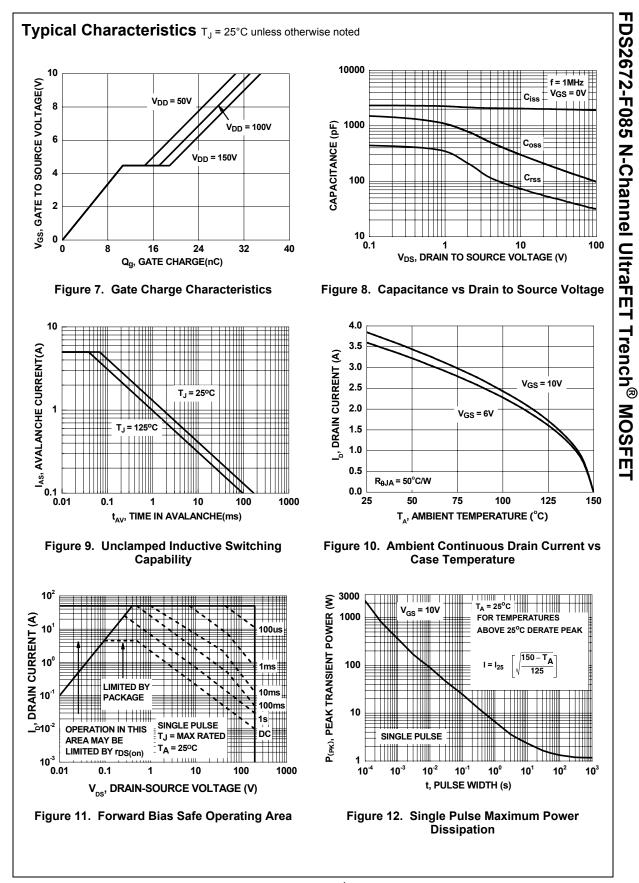




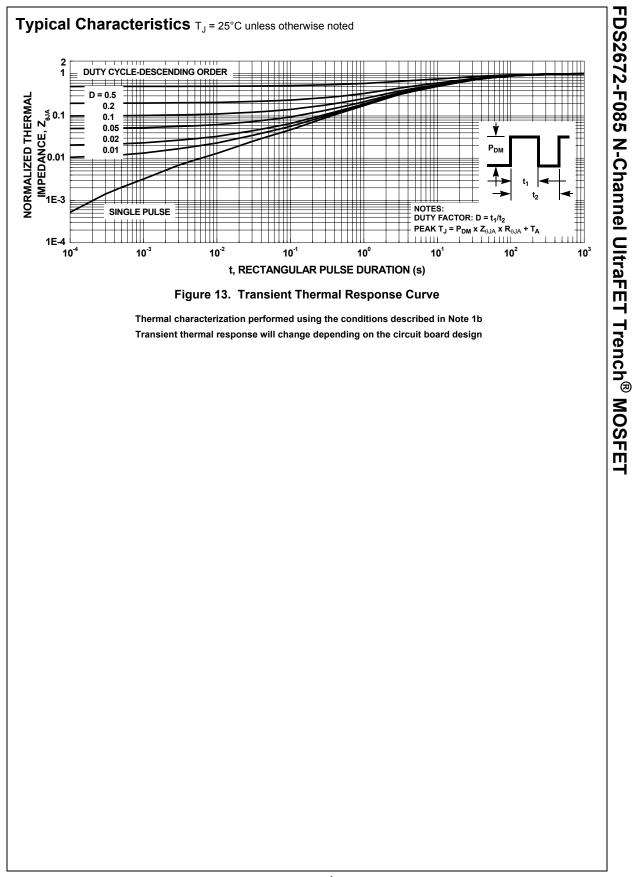
b) 125°C/W when mounted on a minimum pad .



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